HALOGEN

FREE





N-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY							
V _{DS(min)} (V)	$R_{DS(on)}\left(\Omega\right)$	V _{GS(th)} (V)	I _D (mA)				
60	1.40 at V _{GS} = 10 V	1 to 2.5	500				

SC-89 Sc-89 Sq. Marking Code: E Top View

Ordering Information: Si1026X-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Low On-Resistance: 1.40 Ω
 Low Threshold: 2 V (typ.)
 Low Input Capacitance: 30 pF
- Fast Switching Speed: 15 ns (typ.)
- Low Input and Output Leakage
- ESD Protected: 2000 V
- Miniature Package
- Compliant to RoHS Directive 2002/95/EC

BENEFITS

- · Low Offset Voltage
- Low-Voltage Operation
- High-Speed Circuits
- Low Error Voltage
- Small Board Area

APPLICATIONS

- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.
- Battery Operated Systems
- Solid-State Relays

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 ^{\circ}C$, unle	ess otherwise	noted)			
Parameter	Symbol	5 s	Steady State	Unit		
Drain-Source Voltage		V_{DS}	60		V	
Gate-Source Voltage		V _{GS}	± 20			
Continuous Drain Comment /T 450 °C)	T _A = 25 °C	I _D	320	305		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 85 °C		230	220	A	
Pulsed Drain Current ^b		I _{DM}	- 650		mA	
Continuous Source Current (Diode Conduction) ^a		I _S	450	380		
	T _A = 25 °C	P _D	280	250	mW	
Maximum Power Dissipation ^a	T _A = 85 °C		145	130	IIIVV	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	
Gate-Source ESD Rating (HBM, Method 3015)		ESD	2000		V	

Notes:

- a. Surface mounted on FR4 board.
- b. Pulse width limited by maximum junction temperature.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 10 \mu\text{A}$	60			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 0.25 \text{ mA}$	1		2.5		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 10 \text{ V}$			± 150	nA	
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 5 \text{ V}$			± 50		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V			1	μА	
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$			10		
On-State Drain Current ^a		V _{DS} = 10 V, V _{GS} = 4.5 V	500			mA	
	I _{D(on)}	$V_{DS} = 7.5 \text{ V}, V_{GS} = 10 \text{ V}$	800				
Drain-Source On-Resistance ^a		$V_{GS} = 4.5 \text{ V}, I_D = 200 \text{ mA}$			3.0	Ω	
	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 500 \text{ mA}$			1.40		
		$V_{GS} = 10 \text{ V}, I_D = 500 \text{ mA}, T_J = 125 \text{ °C}$			2.50		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 200 mA		200		mS	
Diode Forward Voltage ^a	V_{SD}	V _{GS} = 0 V, I _S = 200 mA			1.40	V	
Dynamic ^b							
Total Gate Charge	Q_g			600		pC	
Gate-Source Charge	Q_{gs}	$V_{DS} = 10 \text{ V}, I_D = 250 \text{ mA}, V_{GS} = 4.5 \text{ V}$		120			
Gate-Drain Charge	Q_{gd}			225			
Input Capacitance	C _{iss}	V 05VV 0V		30		pF	
Output Capacitance	C _{oss}	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1 MHz		6			
Reverse Transfer Capacitance	C _{rss}	1 = 1 1/11/12		3			
Switching ^{b, c}			•				
Turn-On Time	t _(on)	V_{DD} = 30 V, R_L = 150 Ω		15			
Turn-Off Time	t _(off)	I_D = 200 mA, V_{GEN} = 10 V, R_g = 10 Ω		20		ns	

Notes:

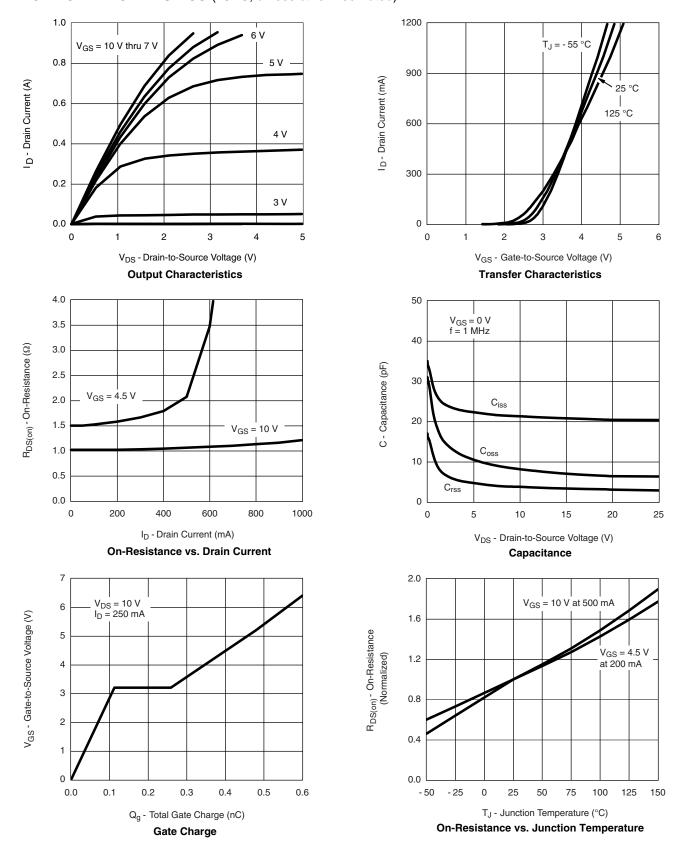
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. For DESIGN AID ONLY, not subject to production testing.
- c. Switching time is essentially independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





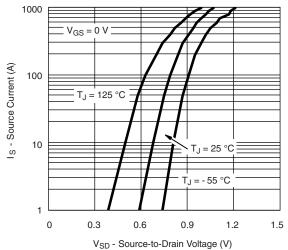
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

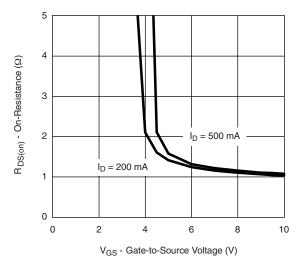


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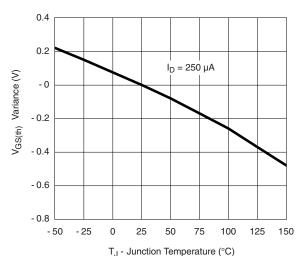
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



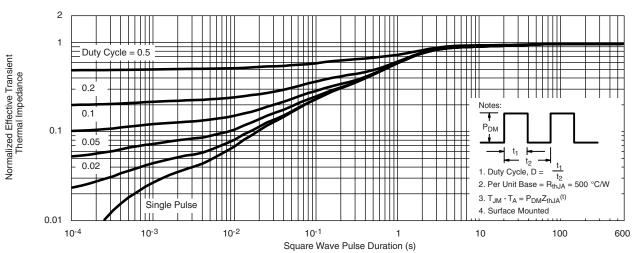


Source-Drain Diode Forward Voltage

On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage Variance Over Temperature



Normalized Thermal Transient Impedance, Junction-to-Ambient

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